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### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, POR, WDT
Number of I/O	13
Program Memory Size	1.75KB (1K x 14)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	68 x 8
Voltage - Supply (Vcc/Vdd)	4V ~ 6V
Data Converters	A/D 4x8b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	18-SOIC (0.295", 7.50mm Width)
Supplier Device Package	18-SOIC
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/pic16c711-20i-so">https://www.e-xfl.com/product-detail/microchip-technology/pic16c711-20i-so</a>

# PIC16C71X

TABLE 1-1: PIC16C71X FAMILY OF DEVICES

		PIC16C710	PIC16C71	PIC16C711	PIC16C715	PIC16C72	PIC16CR72 <sup>(1)</sup>
<b>Clock</b>	Maximum Frequency of Operation (MHz)	20	20	20	20	20	20
<b>Memory</b>	EPROM Program Memory (x14 words)	512	1K	1K	2K	2K	—
	ROM Program Memory (14K words)	—	—	—	—	—	2K
	Data Memory (bytes)	36	36	68	128	128	128
<b>Peripherals</b>	Timer Module(s)	TMR0	TMR0	TMR0	TMR0	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2
	Capture/Compare/PWM Module(s)	—	—	—	—	1	1
	Serial Port(s) (SPI/I <sup>2</sup> C, USART)	—	—	—	—	SPI/I <sup>2</sup> C	SPI/I <sup>2</sup> C
	Parallel Slave Port	—	—	—	—	—	—
	A/D Converter (8-bit) Channels	4	4	4	4	5	5
<b>Features</b>	Interrupt Sources	4	4	4	4	8	8
	I/O Pins	13	13	13	13	22	22
	Voltage Range (Volts)	2.5-6.0	3.0-6.0	2.5-6.0	2.5-5.5	2.5-6.0	3.0-5.5
	In-Circuit Serial Programming	Yes	Yes	Yes	Yes	Yes	Yes
	Brown-out Reset	Yes	—	Yes	Yes	Yes	Yes
	Packages	18-pin DIP, SOIC; 20-pin SSOP	18-pin DIP, SOIC	18-pin DIP, SOIC; 20-pin SSOP	18-pin DIP, SOIC; 20-pin SSOP	28-pin SDIP, SOIC, SSOP	28-pin SDIP, SOIC, SSOP

		PIC16C73A	PIC16C74A	PIC16C76	PIC16C77
<b>Clock</b>	Maximum Frequency of Operation (MHz)	20	20	20	20
<b>Memory</b>	EPROM Program Memory (x14 words)	4K	4K	8K	8K
	Data Memory (bytes)	192	192	376	376
<b>Peripherals</b>	Timer Module(s)	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2
	Capture/Compare/PWM Module(s)	2	2	2	2
	Serial Port(s) (SPI/I <sup>2</sup> C, USART)	SPI/I <sup>2</sup> C, USART	SPI/I <sup>2</sup> C, USART	SPI/I <sup>2</sup> C, USART	SPI/I <sup>2</sup> C, USART
	Parallel Slave Port	—	Yes	—	Yes
	A/D Converter (8-bit) Channels	5	8	5	8
<b>Features</b>	Interrupt Sources	11	12	11	12
	I/O Pins	22	33	22	33
	Voltage Range (Volts)	2.5-6.0	2.5-6.0	2.5-6.0	2.5-6.0
	In-Circuit Serial Programming	Yes	Yes	Yes	Yes
	Brown-out Reset	Yes	Yes	Yes	Yes
	Packages	28-pin SDIP, SOIC	40-pin DIP; 44-pin PLCC, MQFP, TQFP	28-pin SDIP, SOIC	40-pin DIP; 44-pin PLCC, MQFP, TQFP

All PIC16/17 Family devices have Power-on Reset, selectable Watchdog Timer, selectable code protect and high I/O current capability. All PIC16C7XX Family devices use serial programming with clock pin RB6 and data pin RB7.

Note 1: Please contact your local Microchip sales office for availability of these devices.

# PIC16C71X

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NOTES:

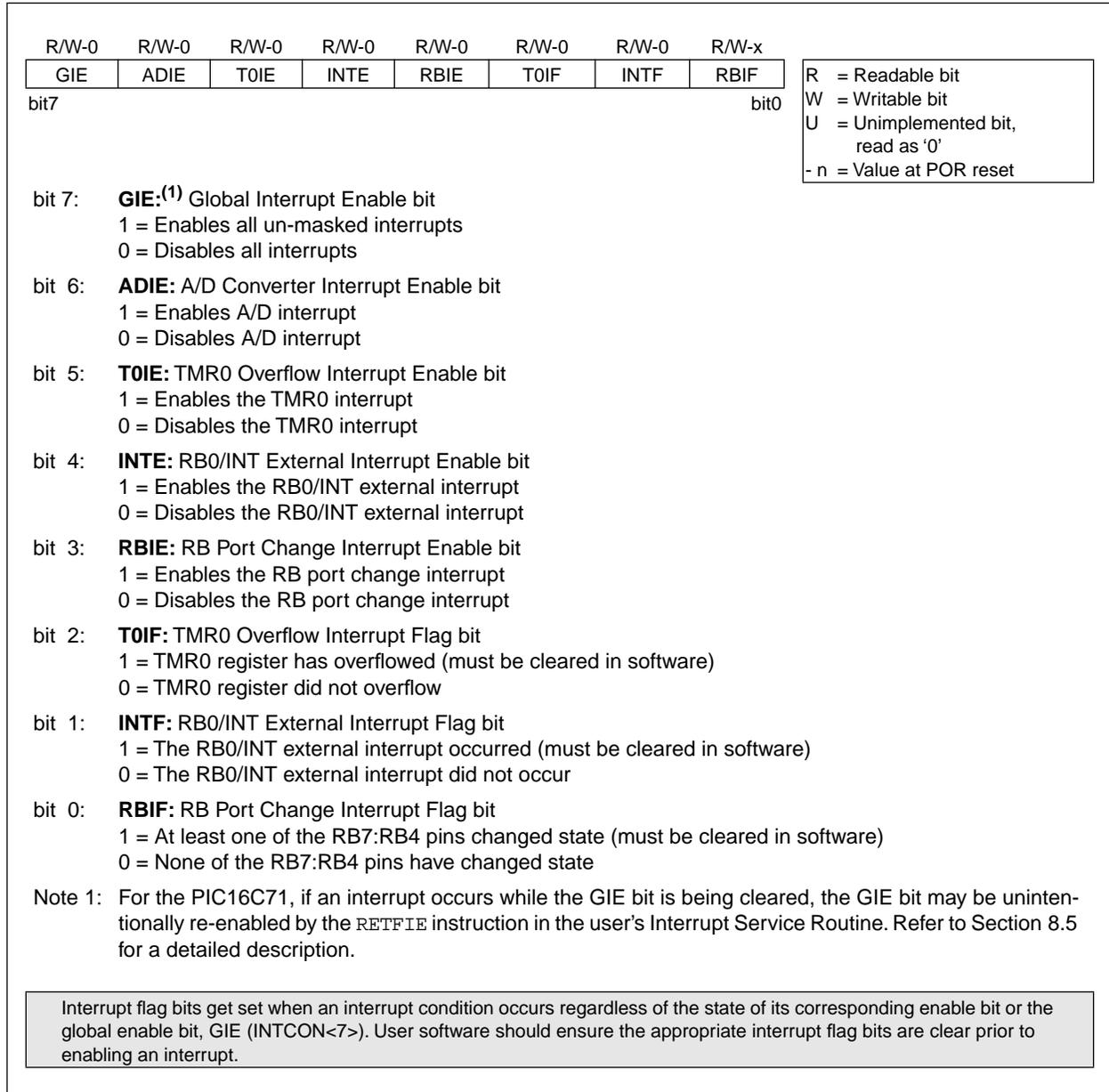
## 4.2.2.3 INTCON REGISTER

**Applicable Devices** 710 71 711 715

The INTCON Register is a readable and writable register which contains various enable and flag bits for the TMR0 register overflow, RB Port change and External RB0/INT pin interrupts.

**Note:** Interrupt flag bits get set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>).

**FIGURE 4-9: INTCON REGISTER (ADDRESS 0Bh, 8Bh)**



# PIC16C71X

Example 4-1 shows the calling of a subroutine in page 1 of the program memory. This example assumes that PCLATH is saved and restored by the interrupt service routine (if interrupts are used).

## EXAMPLE 4-1: CALL OF A SUBROUTINE IN PAGE 1 FROM PAGE 0

```

ORG 0x500
BSF   PCLATH,3 ;Select page 1 (800h-FFFh)
BCF   PCLATH,4 ;Only on >4K devices
CALL  SUB1_P1  ;Call subroutine in
      :        ;page 1 (800h-FFFh)
      :
      :
ORG 0x900
SUB1_P1:      ;called subroutine
      :        ;page 1 (800h-FFFh)
      :
RETURN        ;return to Call subroutine
              ;in page 0 (000h-7FFh)
    
```

## 4.5 Indirect Addressing, INDF and FSR Registers

The INDF register is not a physical register. Addressing the INDF register will cause indirect addressing.

Indirect addressing is possible by using the INDF register. Any instruction using the INDF register actually accesses the register pointed to by the File Select Register, FSR. Reading the INDF register itself indirectly (FSR = '0') will read 00h. Writing to the INDF register indirectly results in a no-operation (although status bits may be affected). An effective 9-bit address is obtained by concatenating the 8-bit FSR register and the IRP bit (STATUS<7>), as shown in Figure 4-15. However, IRP is not used in the PIC16C71X devices.

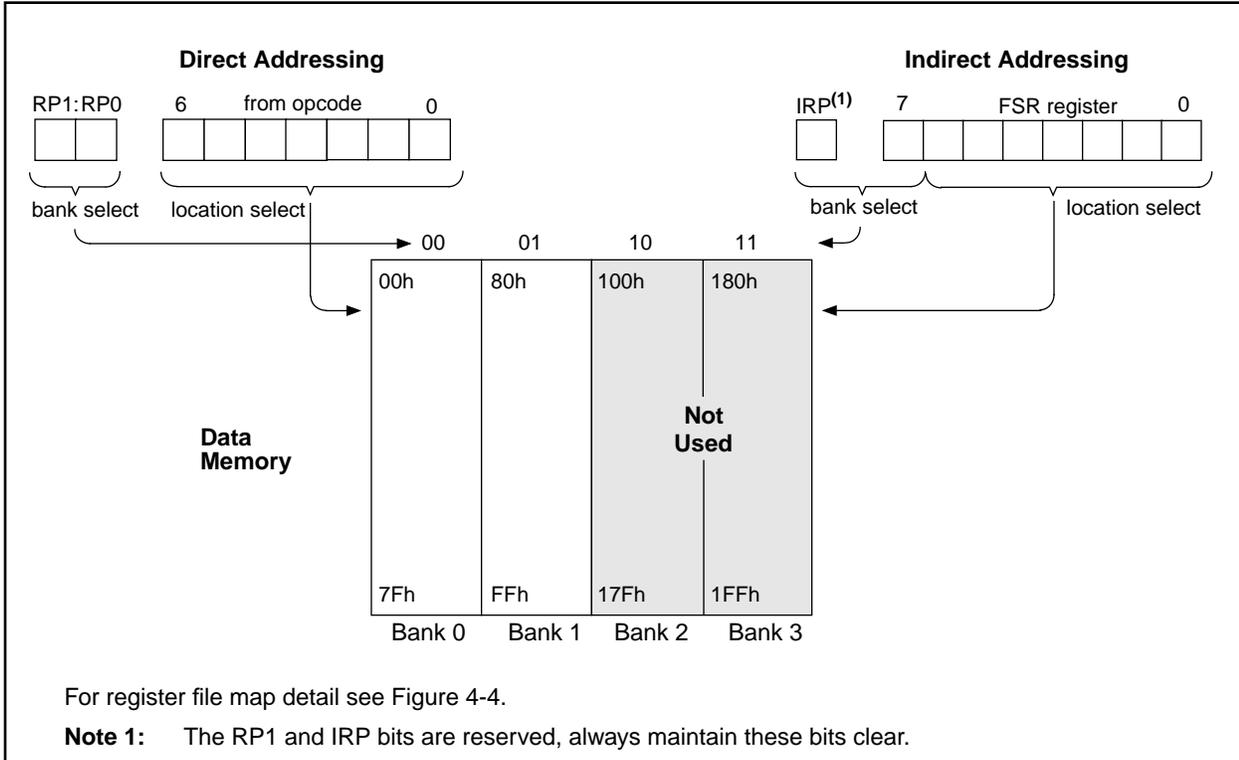
A simple program to clear RAM locations 20h-2Fh using indirect addressing is shown in Example 4-2.

## EXAMPLE 4-2: INDIRECT ADDRESSING

```

      movlw 0x20 ;initialize pointer
      movwf FSR ;to RAM
NEXT   clrf  INDF ;clear INDF register
      incf  FSR,F ;inc pointer
      btfss FSR,4 ;all done?
      goto  NEXT ;no clear next
CONTINUE
      :          ;yes continue
    
```

FIGURE 4-15: DIRECT/INDIRECT ADDRESSING



## 6.0 TIMER0 MODULE

**Applicable Devices** 710 71 711 715

The Timer0 module timer/counter has the following features:

- 8-bit timer/counter
- Readable and writable
- 8-bit software programmable prescaler
- Internal or external clock select
- Interrupt on overflow from FFh to 00h
- Edge select for external clock

Figure 6-1 is a simplified block diagram of the Timer0 module.

Timer mode is selected by clearing bit T0CS (OPTION<5>). In timer mode, the Timer0 module will increment every instruction cycle (without prescaler). If the TMR0 register is written, the increment is inhibited for the following two instruction cycles (Figure 6-2 and Figure 6-3). The user can work around this by writing an adjusted value to the TMR0 register.

Counter mode is selected by setting bit T0CS (OPTION<5>). In counter mode, Timer0 will increment either on every rising or falling edge of pin RA4/T0CKI. The incrementing edge is determined by the Timer0 Source Edge Select bit T0SE (OPTION<4>). Clearing

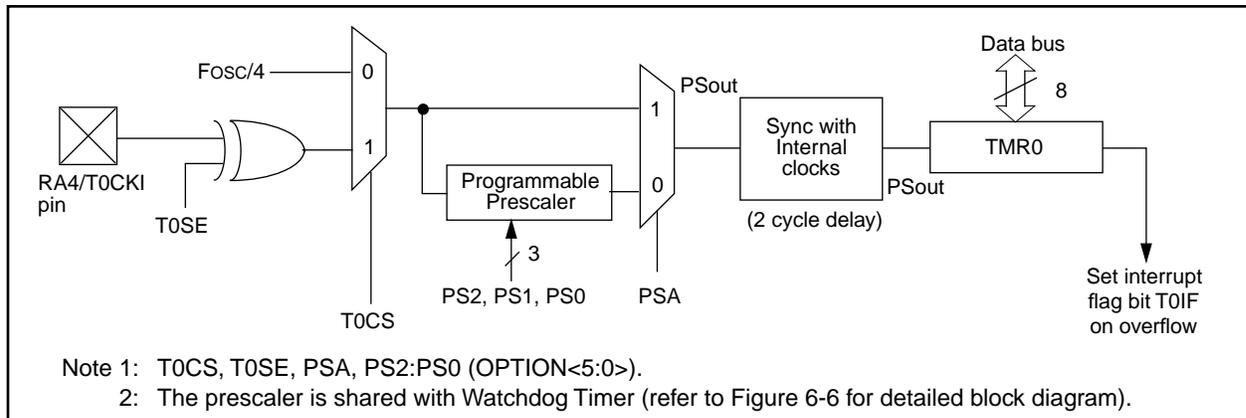
bit T0SE selects the rising edge. Restrictions on the external clock input are discussed in detail in Section 6.2.

The prescaler is mutually exclusively shared between the Timer0 module and the Watchdog Timer. The prescaler assignment is controlled in software by control bit PSA (OPTION<3>). Clearing bit PSA will assign the prescaler to the Timer0 module. The prescaler is not readable or writable. When the prescaler is assigned to the Timer0 module, prescale values of 1:2, 1:4, ..., 1:256 are selectable. Section 6.3 details the operation of the prescaler.

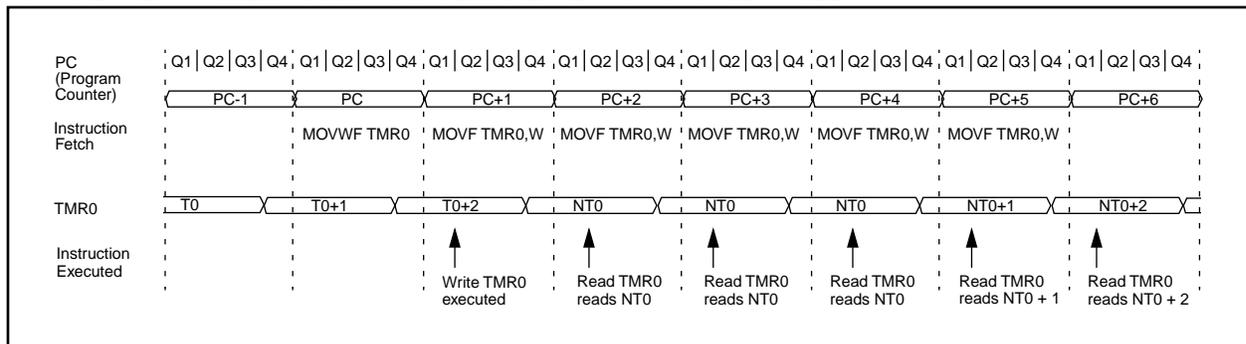
### 6.1 Timer0 Interrupt

The TMR0 interrupt is generated when the TMR0 register overflows from FFh to 00h. This overflow sets bit T0IF (INTCON<2>). The interrupt can be masked by clearing bit T0IE (INTCON<5>). Bit T0IF must be cleared in software by the Timer0 module interrupt service routine before re-enabling this interrupt. The TMR0 interrupt cannot awaken the processor from SLEEP since the timer is shut off during SLEEP. See Figure 6-4 for Timer0 interrupt timing.

**FIGURE 6-1: TIMER0 BLOCK DIAGRAM**



**FIGURE 6-2: TIMER0 TIMING: INTERNAL CLOCK/NO PRESCALE**



# PIC16C71X

## 8.3 Reset

**Applicable Devices** 710 71 711 715

The PIC16CXX differentiates between various kinds of reset:

- Power-on Reset (POR)
- $\overline{\text{MCLR}}$  reset during normal operation
- $\overline{\text{MCLR}}$  reset during SLEEP
- WDT Reset (normal operation)
- Brown-out Reset (BOR) (PIC16C710/711/715)
- Parity Error Reset (PIC16C715)

Some registers are not affected in any reset condition; their status is unknown on POR and unchanged in any other reset. Most other registers are reset to a "reset state" on Power-on Reset (POR), on the  $\overline{\text{MCLR}}$  and

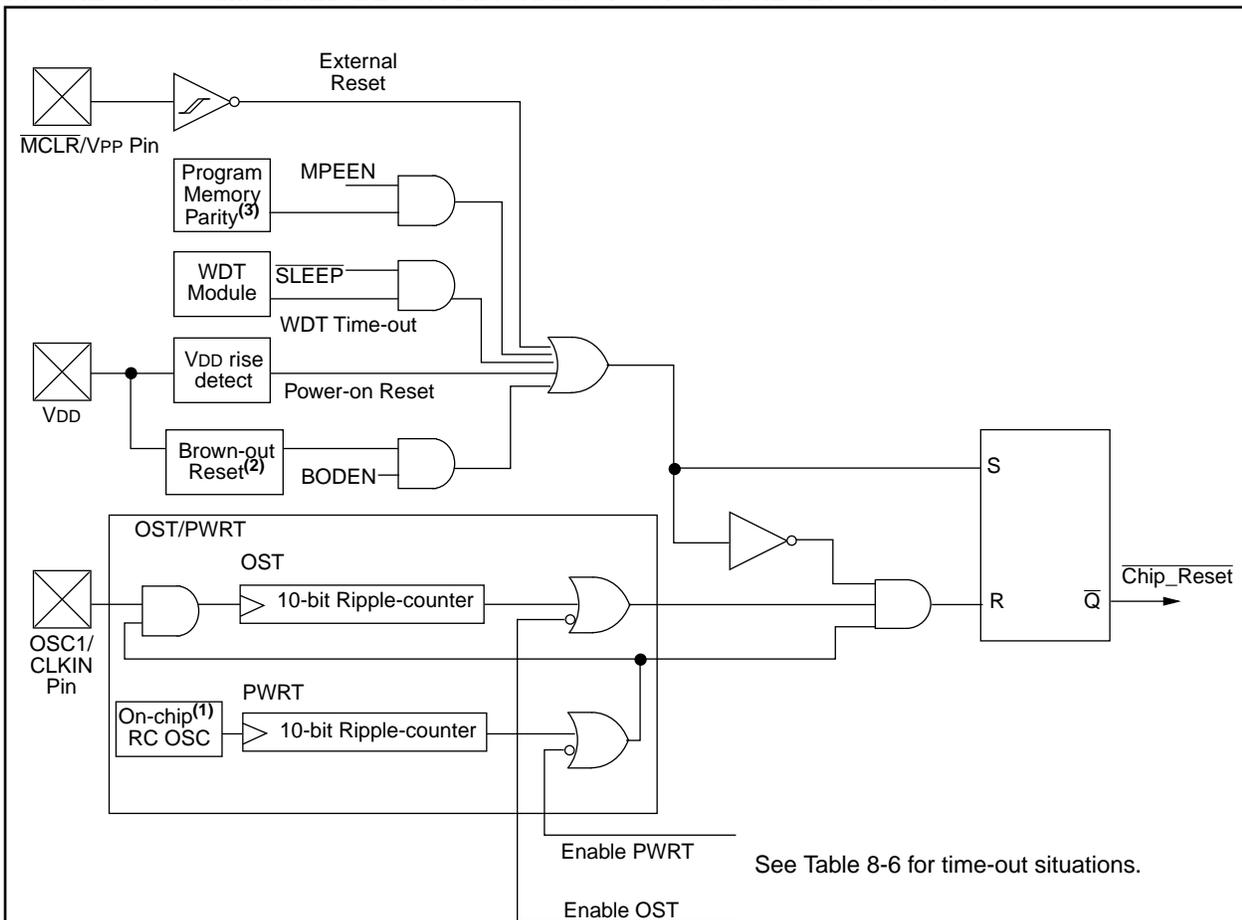
WDT Reset, on  $\overline{\text{MCLR}}$  reset during SLEEP, and Brown-out Reset (BOR). They are not affected by a WDT Wake-up, which is viewed as the resumption of normal operation. The  $\overline{\text{TO}}$  and  $\overline{\text{PD}}$  bits are set or cleared differently in different reset situations as indicated in Table 8-7, Table 8-8 and Table 8-9. These bits are used in software to determine the nature of the reset. See Table 8-10 and Table 8-11 for a full description of reset states of all registers.

A simplified block diagram of the on-chip reset circuit is shown in Figure 8-9.

The PIC16C710/711/715 have a  $\overline{\text{MCLR}}$  noise filter in the  $\overline{\text{MCLR}}$  reset path. The filter will detect and ignore small pulses.

It should be noted that a WDT Reset does not drive  $\overline{\text{MCLR}}$  pin low.

**FIGURE 8-9: SIMPLIFIED BLOCK DIAGRAM OF ON-CHIP RESET CIRCUIT**



- Note 1: This is a separate oscillator from the RC oscillator of the CLKIN pin.  
 Note 2: Brown-out Reset is implemented on the PIC16C710/711/715.  
 Note 3: Parity Error Reset is implemented on the PIC16C715.

**TABLE 8-12: INITIALIZATION CONDITIONS FOR ALL REGISTERS, PIC16C710/71/711**

Register	Power-on Reset, Brown-out Reset <sup>(5)</sup>	MCLR Resets WDT Reset	Wake-up via WDT or Interrupt
W	xxxx xxxx	uuuu uuuu	uuuu uuuu
INDF	N/A	N/A	N/A
TMR0	xxxx xxxx	uuuu uuuu	uuuu uuuu
PCL	0000h	0000h	PC + 1 <sup>(2)</sup>
STATUS	0001 1xxx	000q quuu <sup>(3)</sup>	uuuq quuu <sup>(3)</sup>
FSR	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTA	---x 0000	---u 0000	---u uuuu
PORTB	xxxx xxxx	uuuu uuuu	uuuu uuuu
PCLATH	---0 0000	---0 0000	---u uuuu
INTCON	0000 000x	0000 000u	uuuu uuuu <sup>(1)</sup>
ADRES	xxxx xxxx	uuuu uuuu	uuuu uuuu
ADCON0	00-0 0000	00-0 0000	uu-u uuuu
OPTION	1111 1111	1111 1111	uuuu uuuu
TRISA	---1 1111	---1 1111	---u uuuu
TRISB	1111 1111	1111 1111	uuuu uuuu
PCON <sup>(4)</sup>	---- --0u	---- --uu	---- --uu
ADCON1	---- --00	---- --00	---- --uu

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition

Note 1: One or more bits in INTCON will be affected (to cause wake-up).

2: When the wake-up is due to an interrupt and the GIE bit is set, the PC is loaded with the interrupt vector (0004h).

3: See Table 8-10 for reset value for specific condition.

4: The PCON register is not implemented on the PIC16C71.

5: Brown-out reset is not implemented on the PIC16C71.

# PIC16C71X

TABLE 9-2: PIC16CXX INSTRUCTION SET

Mnemonic, Operands	Description	Cycles	14-Bit Opcode			Status Affected	Notes	
			MSb	LSb				
<b>BYTE-ORIENTED FILE REGISTER OPERATIONS</b>								
<b>ADDWF</b>	f, d	Add W and f	1	00	0111	dfff ffff	C,DC,Z	1,2
<b>ANDWF</b>	f, d	AND W with f	1	00	0101	dfff ffff	Z	1,2
<b>CLRF</b>	f	Clear f	1	00	0001	1fff ffff	Z	2
<b>CLRWF</b>	-	Clear W	1	00	0001	0xxx xxxx	Z	
<b>COMF</b>	f, d	Complement f	1	00	1001	dfff ffff	Z	1,2
<b>DECF</b>	f, d	Decrement f	1	00	0011	dfff ffff	Z	1,2
<b>DECFSZ</b>	f, d	Decrement f, Skip if 0	1(2)	00	1011	dfff ffff		1,2,3
<b>INCF</b>	f, d	Increment f	1	00	1010	dfff ffff	Z	1,2
<b>INCFSZ</b>	f, d	Increment f, Skip if 0	1(2)	00	1111	dfff ffff		1,2,3
<b>IORWF</b>	f, d	Inclusive OR W with f	1	00	0100	dfff ffff	Z	1,2
<b>MOVF</b>	f, d	Move f	1	00	1000	dfff ffff	Z	1,2
<b>MOVWF</b>	f	Move W to f	1	00	0000	1fff ffff		
<b>NOP</b>	-	No Operation	1	00	0000	0xx0 0000		
<b>RLF</b>	f, d	Rotate Left f through Carry	1	00	1101	dfff ffff	C	1,2
<b>RRF</b>	f, d	Rotate Right f through Carry	1	00	1100	dfff ffff	C	1,2
<b>SUBWF</b>	f, d	Subtract W from f	1	00	0010	dfff ffff	C,DC,Z	1,2
<b>SWAPF</b>	f, d	Swap nibbles in f	1	00	1110	dfff ffff		1,2
<b>XORWF</b>	f, d	Exclusive OR W with f	1	00	0110	dfff ffff	Z	1,2
<b>BIT-ORIENTED FILE REGISTER OPERATIONS</b>								
<b>BCF</b>	f, b	Bit Clear f	1	01	00bb	bfff ffff		1,2
<b>BSF</b>	f, b	Bit Set f	1	01	01bb	bfff ffff		1,2
<b>BTFSC</b>	f, b	Bit Test f, Skip if Clear	1 (2)	01	10bb	bfff ffff		3
<b>BTFSS</b>	f, b	Bit Test f, Skip if Set	1 (2)	01	11bb	bfff ffff		3
<b>LITERAL AND CONTROL OPERATIONS</b>								
<b>ADDLW</b>	k	Add literal and W	1	11	111x	kkkk kkkk	C,DC,Z	
<b>ANDLW</b>	k	AND literal with W	1	11	1001	kkkk kkkk	Z	
<b>CALL</b>	k	Call subroutine	2	10	0kkk	kkkk kkkk		
<b>CLRWDT</b>	-	Clear Watchdog Timer	1	00	0000	0110 0100	$\overline{TO}, \overline{PD}$	
<b>GOTO</b>	k	Go to address	2	10	1kkk	kkkk kkkk		
<b>IORLW</b>	k	Inclusive OR literal with W	1	11	1000	kkkk kkkk	Z	
<b>MOVLW</b>	k	Move literal to W	1	11	00xx	kkkk kkkk		
<b>RETFIE</b>	-	Return from interrupt	2	00	0000	0000 1001		
<b>RETLW</b>	k	Return with literal in W	2	11	01xx	kkkk kkkk		
<b>RETURN</b>	-	Return from Subroutine	2	00	0000	0000 1000		
<b>SLEEP</b>	-	Go into standby mode	1	00	0000	0110 0011	$\overline{TO}, \overline{PD}$	
<b>SUBLW</b>	k	Subtract W from literal	1	11	110x	kkkk kkkk	C,DC,Z	
<b>XORLW</b>	k	Exclusive OR literal with W	1	11	1010	kkkk kkkk	Z	

- Note 1: When an I/O register is modified as a function of itself ( e.g., `MOVF PORTB, 1`), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.
- 2: If this instruction is executed on the TMR0 register (and, where applicable, d = 1), the prescaler will be cleared if assigned to the Timer0 Module.
- 3: If Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.

## **BTFSS**      **Bit Test f, Skip if Set**

**Syntax:**            *[label]* BTFSS *f*,*b*

**Operands:**         $0 \leq f \leq 127$   
 $0 \leq b < 7$

**Operation:**        skip if (f<*b*>) = 1

**Status Affected:** None

**Encoding:**

01	11bb	bfff	ffff
----	------	------	------

**Description:**     If bit 'b' in register 'f' is '0' then the next instruction is executed.  
 If bit 'b' is '1', then the next instruction is discarded and a NOP is executed instead, making this a 2TCY instruction.

**Words:**            1

**Cycles:**            1(2)

**Q Cycle Activity:**

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process data	NOP

**If Skip:**            (2nd Cycle)

Q1	Q2	Q3	Q4
NOP	NOP	NOP	NOP

**Example**

```

HERE   BTFSC  FLAG, 1
FALSE  GOTO  PROCESS_CODE
TRUE   •
        •
        •
  
```

**Before Instruction**  
 PC = address HERE

**After Instruction**  
 if FLAG<1> = 0,  
 PC = address FALSE  
 if FLAG<1> = 1,  
 PC = address TRUE

## **CALL**            **Call Subroutine**

**Syntax:**            [*label*] CALL *k*

**Operands:**         $0 \leq k \leq 2047$

**Operation:**        (PC)+ 1 → TOS,  
*k* → PC<10:0>,  
 (PCLATH<4:3>) → PC<12:11>

**Status Affected:** None

**Encoding:**

10	0kkk	kkkk	kkkk
----	------	------	------

**Description:**     Call Subroutine. First, return address (PC+1) is pushed onto the stack. The eleven bit immediate address is loaded into PC bits <10:0>. The upper bits of the PC are loaded from PCLATH. CALL is a two cycle instruction.

**Words:**            1

**Cycles:**            2

**Q Cycle Activity:**

Q1	Q2	Q3	Q4
Decode	Read literal 'k', Push PC to Stack	Process data	Write to PC

**1st Cycle**

Decode	Read literal 'k', Push PC to Stack	Process data	Write to PC
--------	------------------------------------	--------------	-------------

**2nd Cycle**

NOP	NOP	NOP	NOP
-----	-----	-----	-----

**Example**

```

HERE   CALL  THERE
  
```

**Before Instruction**  
 PC = Address HERE

**After Instruction**  
 PC = Address THERE  
 TOS = Address HERE+1

# PIC16C71X

## CLRF Clear f

Syntax: `[label] CLRF f`

Operands:  $0 \leq f \leq 127$

Operation:  $00h \rightarrow (f)$   
 $1 \rightarrow Z$

Status Affected: Z

Encoding: 

00	0001	1fff	ffff
----	------	------	------

Description: The contents of register 'f' are cleared and the Z bit is set.

Words: 1

Cycles: 1

Q Cycle Activity: 

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process data	Write register 'f'

Example

```

CLRF    FLAG_REG
Before Instruction
FLAG_REG = 0x5A
After Instruction
FLAG_REG = 0x00
Z        = 1
    
```

## CLRW Clear W

Syntax: `[label] CLRW`

Operands: None

Operation:  $00h \rightarrow (W)$   
 $1 \rightarrow Z$

Status Affected: Z

Encoding: 

00	0001	0xxx	xxxx
----	------	------	------

Description: W register is cleared. Zero bit (Z) is set.

Words: 1

Cycles: 1

Q Cycle Activity: 

Q1	Q2	Q3	Q4
Decode	NOP	Process data	Write to W

Example

```

CLRW
Before Instruction
W = 0x5A
After Instruction
W = 0x00
Z = 1
    
```

## CLRWDT Clear Watchdog Timer

Syntax: `[label] CLRWDT`

Operands: None

Operation:  $00h \rightarrow WDT$   
 $0 \rightarrow WDT$  prescaler,  
 $1 \rightarrow \overline{TO}$   
 $1 \rightarrow \overline{PD}$

Status Affected:  $\overline{TO}$ ,  $\overline{PD}$

Encoding: 

00	0000	0110	0100
----	------	------	------

Description: CLRWDT instruction resets the Watchdog Timer. It also resets the prescaler of the WDT. Status bits  $\overline{TO}$  and  $\overline{PD}$  are set.

Words: 1

Cycles: 1

Q Cycle Activity: 

Q1	Q2	Q3	Q4
Decode	NOP	Process data	Clear WDT Counter

Example

```

CLRWDT
Before Instruction
WDT counter = ?
After Instruction
WDT counter = 0x00
WDT prescaler = 0
 $\overline{TO}$  = 1
 $\overline{PD}$  = 1
    
```

# PIC16C71X

TABLE 10-1: DEVELOPMENT TOOLS FROM MICROCHIP

	PIC12C5XX	PIC14000	PIC16C5X	PIC16CXXX	PIC16C6X	PIC16C7XX	PIC16C8X	PIC16C9XX	PIC17C4X	PIC17C75X	24CXX 25CXX 93CXX	HCS200 HCS300 HCS301
<b>Emulator Products</b>												
PICMASTER <sup>®</sup> / PICMASTER-CE In-Circuit Emulator	✓	✓	✓	✓	✓	✓	✓	✓	✓	Available 3097		
ICEPIC Low-Cost In-Circuit Emulator	✓		✓	✓	✓	✓	✓					
<b>Software Tools</b>												
MPLAB <sup>™</sup> Integrated Development Environment	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓		
MPLAB <sup>™</sup> C Compiler	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓		
fuzzyTECH <sup>®</sup> -MP Explorer/Edition Fuzzy Logic Dev. Tool	✓	✓	✓	✓	✓	✓	✓	✓	✓			
MP-DriveWay <sup>™</sup> Applications Code Generator			✓	✓	✓	✓	✓		✓			
Total Endurance <sup>™</sup> Software Model											✓	
<b>Programmers</b>												
PICSTART <sup>®</sup> Lite Ultra Low-Cost Dev. Kit			✓		✓	✓	✓					
PICSTART <sup>®</sup> Plus Low-Cost Universal Dev. Kit	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓
PRO MATE <sup>®</sup> II Universal Programmer	✓	✓	✓	✓	✓	✓	✓		✓	✓	✓	✓
KEELOQ <sup>®</sup> Programmer												
SEEVAL <sup>®</sup> Designers Kit											✓	
<b>Demo Boards</b>												
PICDEM-1		✓		✓			✓		✓			
PICDEM-2					✓							
PICDEM-3								✓				
KEELOQ <sup>®</sup> Evaluation Kit												✓

# PIC16C71X

Applicable Devices 710 71 711 715

FIGURE 11-3: CLKOUT AND I/O TIMING

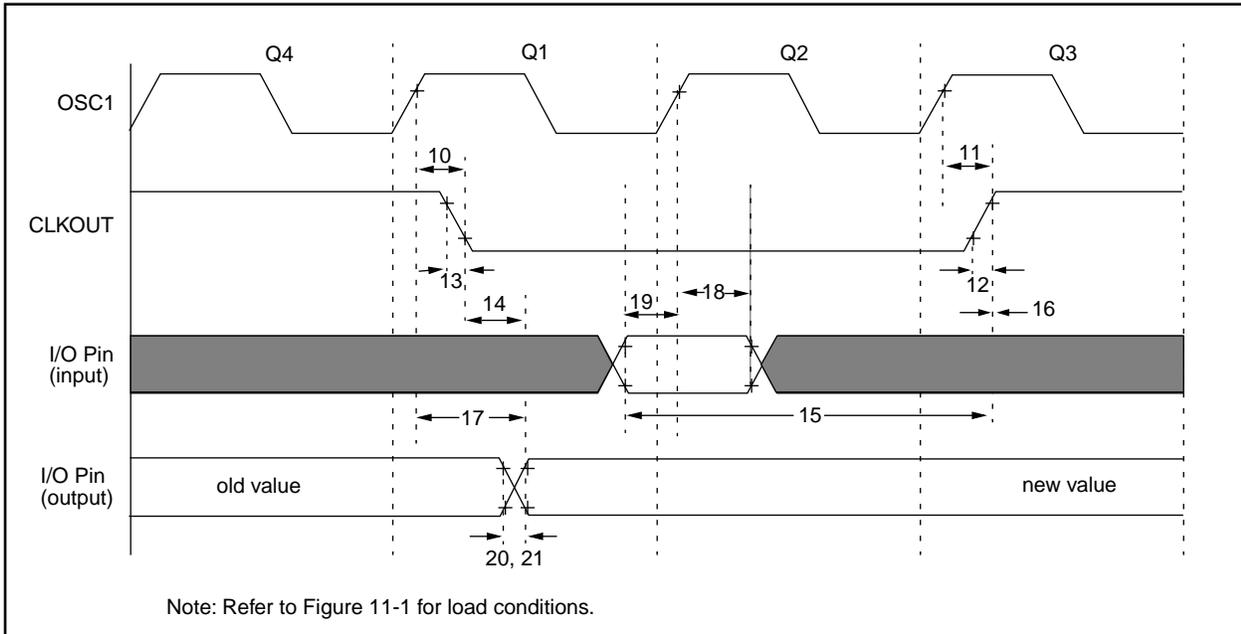


TABLE 11-3: CLKOUT AND I/O TIMING REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
10*	TosH2ckL	OSC1↑ to CLKOUT↓	—	15	30	ns	Note 1
11*	TosH2ckH	OSC1↑ to CLKOUT↑	—	15	30	ns	Note 1
12*	TckR	CLKOUT rise time	—	5	15	ns	Note 1
13*	TckF	CLKOUT fall time	—	5	15	ns	Note 1
14*	TckL2ioV	CLKOUT ↓ to Port out valid	—	—	0.5T <sub>CY</sub> + 20	ns	Note 1
15*	TioV2ckH	Port in valid before CLKOUT ↑	0.25T <sub>CY</sub> + 25	—	—	ns	Note 1
16*	TckH2iol	Port in hold after CLKOUT ↑	0	—	—	ns	Note 1
17*	TosH2ioV	OSC1↑ (Q1 cycle) to Port out valid	—	—	80 - 100	ns	
18*	TosH2iol	OSC1↑ (Q2 cycle) to Port input invalid (I/O in hold time)	TBD	—	—	ns	
19*	TioV2osH	Port input valid to OSC1↑ (I/O in setup time)	TBD	—	—	ns	
20*	TioR	Port output rise time	PIC16C710/711	—	10	25	ns
			PIC16LC710/711	—	—	60	ns
21*	TioF	Port output fall time	PIC16C710/711	—	10	25	ns
			PIC16LC710/711	—	—	60	ns
22††*	Tinp	INT pin high or low time	20	—	—	ns	
23††*	Trbp	RB7:RB4 change INT high or low time	20	—	—	ns	

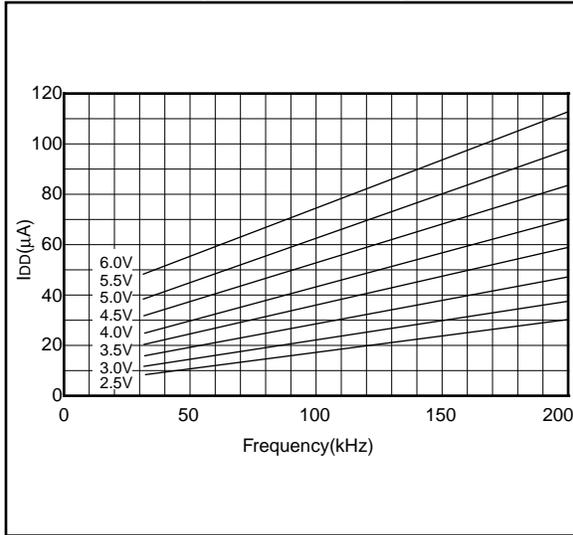
\* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

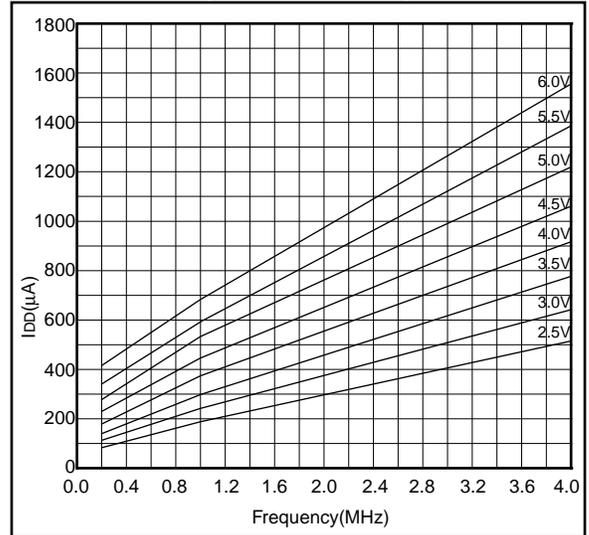
†† These parameters are asynchronous events not related to any internal clock edges.

Note 1: Measurements are taken in RC Mode where CLKOUT output is 4 x T<sub>osc</sub>.

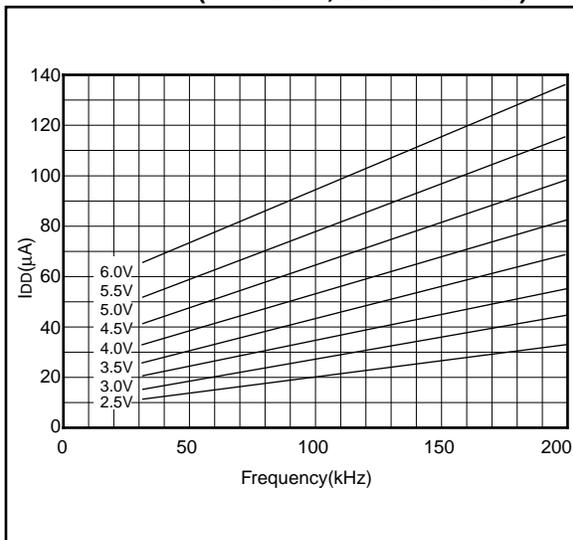
**FIGURE 12-25: TYPICAL I<sub>DD</sub> vs. FREQUENCY  
(LP MODE, 25°C)**



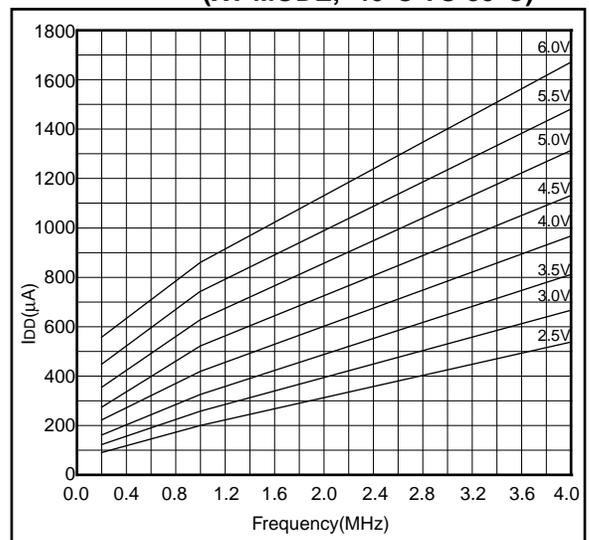
**FIGURE 12-27: TYPICAL I<sub>DD</sub> vs. FREQUENCY  
(XT MODE, 25°C)**



**FIGURE 12-26: MAXIMUM I<sub>DD</sub> vs.  
FREQUENCY  
(LP MODE, 85°C TO -40°C)**



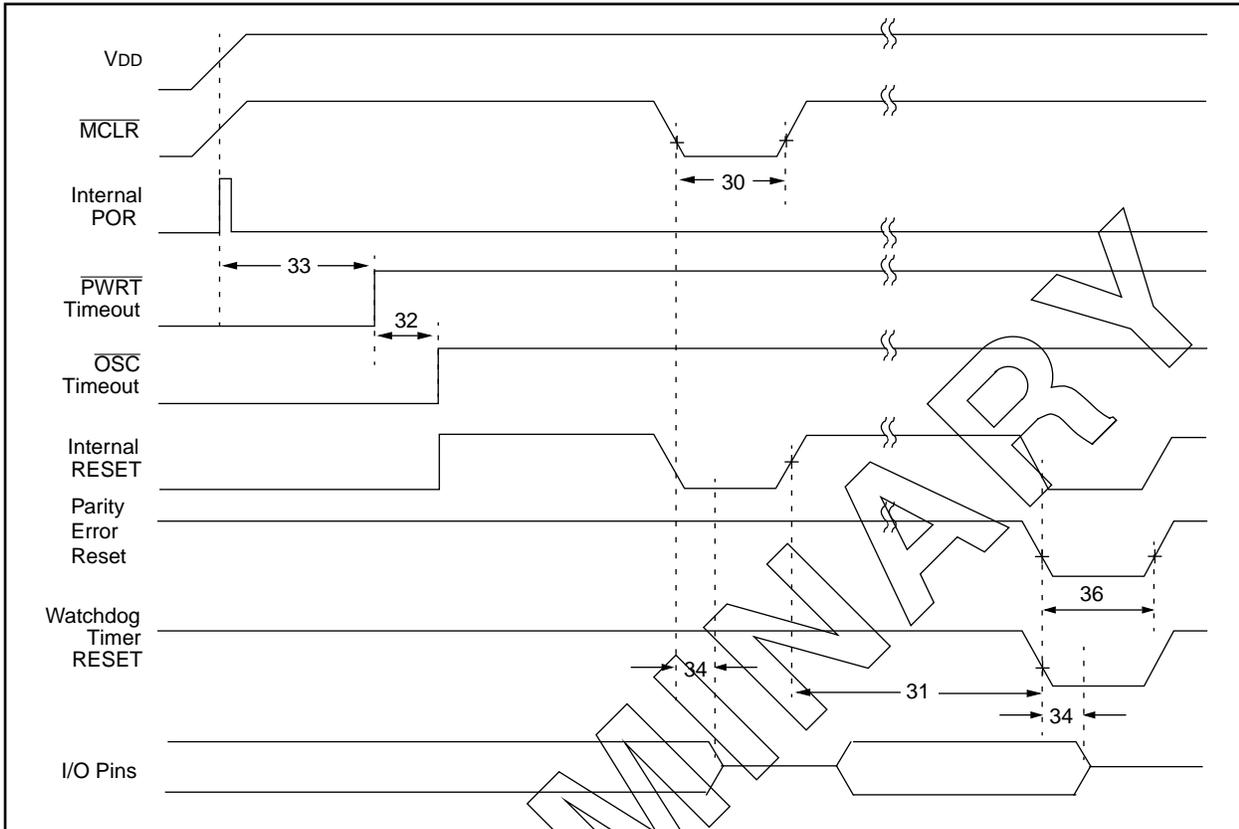
**FIGURE 12-28: MAXIMUM I<sub>DD</sub> vs.  
FREQUENCY  
(XT MODE, -40°C TO 85°C)**



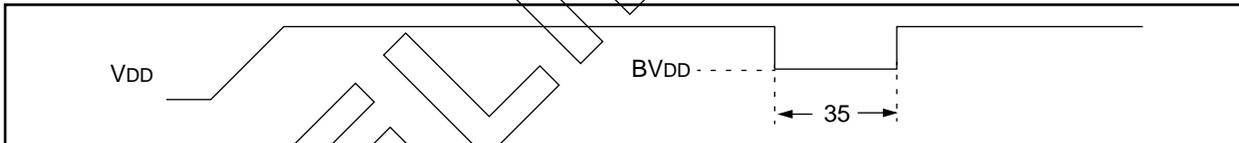
# PIC16C71X

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**FIGURE 13-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, AND POWER-UP TIMER TIMING**



**FIGURE 13-5: BROWN-OUT RESET TIMING**



**TABLE 13-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, POWER-UP TIMER, AND BROWN-OUT RESET REQUIREMENTS**

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
30	Tmcl	MCLR Pulse Width (low)	2	—	—	μs	VDD = 5V, -40°C to +125°C
31*	Twdt	Watchdog Timer Time-out Period (No Prescaler)	7	18	33	ms	VDD = 5V, -40°C to +125°C
32	Tost	Oscillation Start-up Timer Period	—	1024Tosc	—	—	Tosc = OSC1 period
33*	tpwrt	Power up Timer Period	28	72	132	ms	VDD = 5V, -40°C to +125°C
34	Tioz	I/O Hi-impedance from MCLR Low or Watchdog Timer Reset	—	—	2.1	μs	
35	TBOR	Brown-out Reset pulse width	100	—	—	μs	VDD ≤ BVDD (D005)
36	TPER	Parity Error Reset	—	TBD	—	μs	

\* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

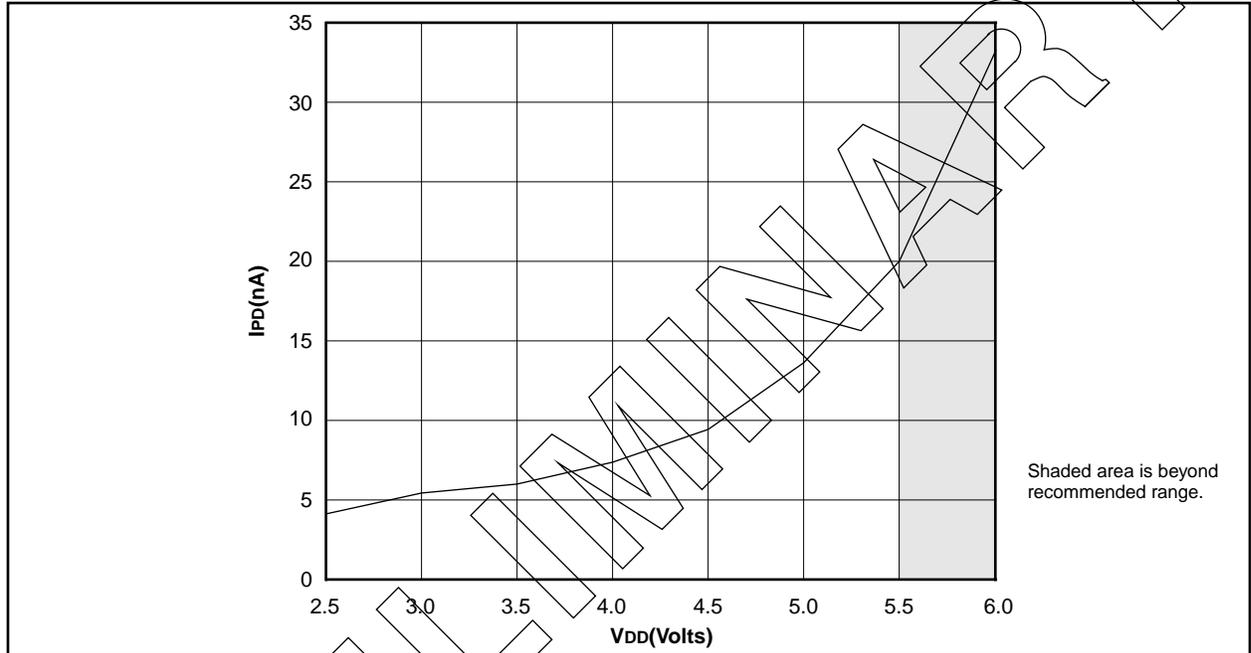
## 14.0 DC AND AC CHARACTERISTICS GRAPHS AND TABLES FOR PIC16C715

The graphs and tables provided in this section are for design guidance and are not tested or guaranteed.

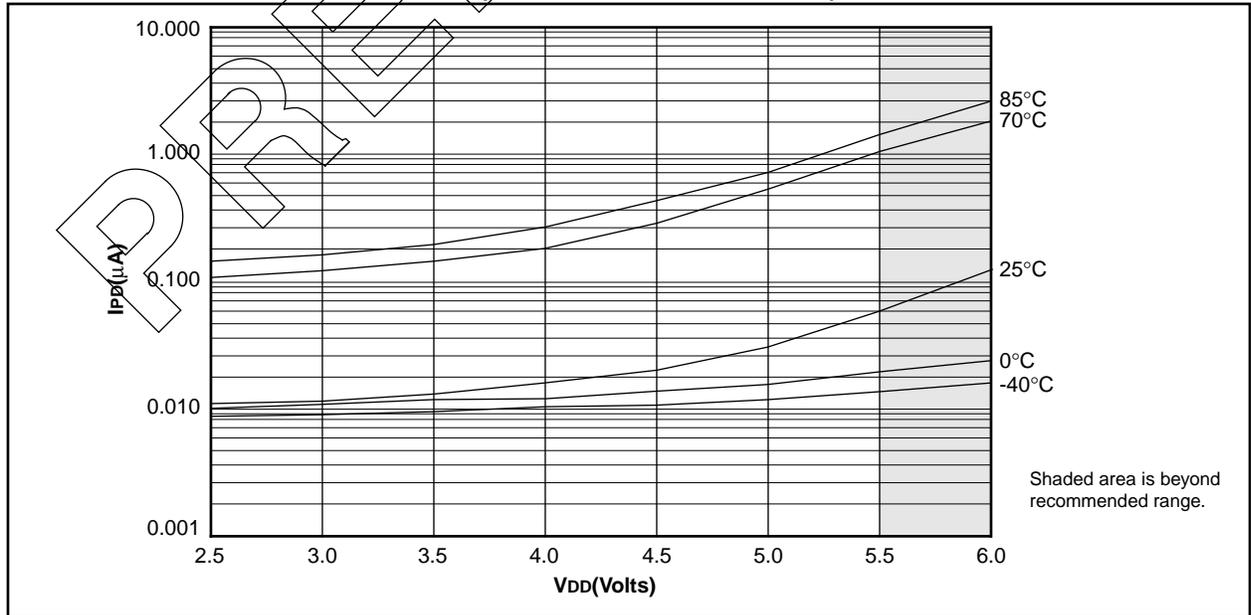
In some graphs or tables the data presented are outside specified operating range (i.e., outside specified  $V_{DD}$  range). This is for information only and devices are guaranteed to operate properly only within the specified range.

**Note:** The data presented in this section is a statistical summary of data collected on units from different lots over a period of time and matrix samples. 'Typical' represents the mean of the distribution at 25°C, while 'max' or 'min' represents (mean +3 $\sigma$ ) and (mean -3 $\sigma$ ) respectively where  $\sigma$  is standard deviation.

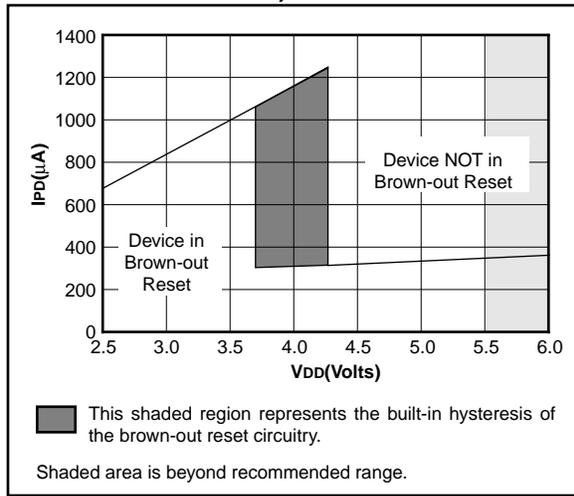
**FIGURE 14-1: TYPICAL  $I_{PD}$  vs.  $V_{DD}$  (WDT DISABLED, RC MODE)**



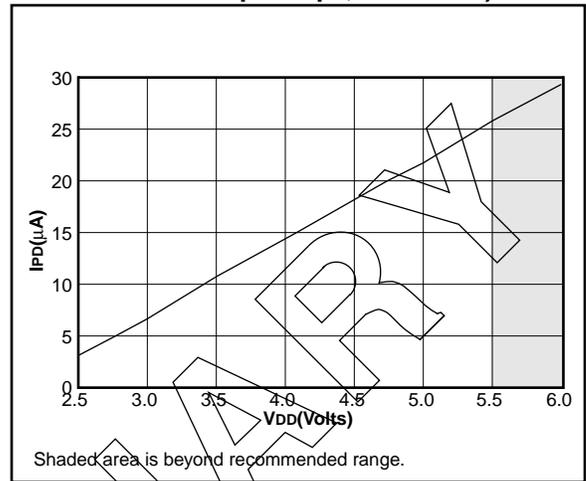
**FIGURE 14-2: MAXIMUM  $I_{PD}$  vs.  $V_{DD}$  (WDT DISABLED, RC MODE)**



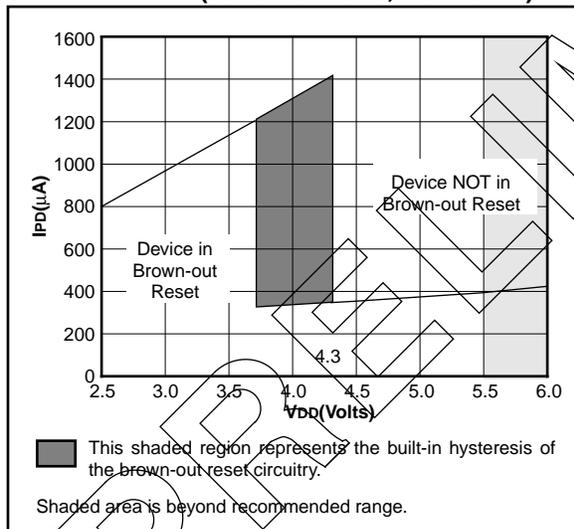
**FIGURE 14-8: TYPICAL  $I_{PD}$  vs.  $V_{DD}$  BROWN-OUT DETECT ENABLED (RC MODE)**



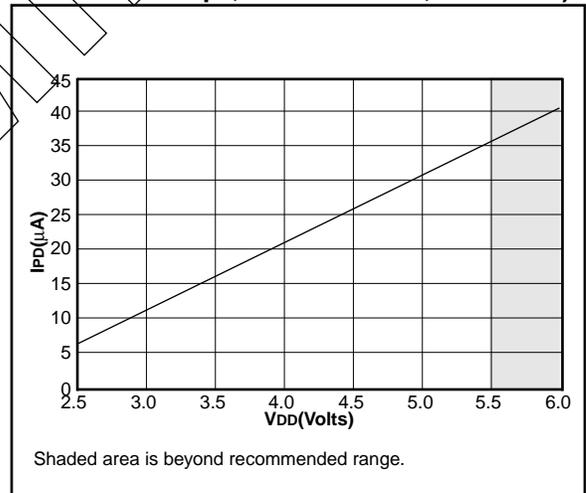
**FIGURE 14-10: TYPICAL  $I_{PD}$  vs. TIMER1 ENABLED (32 kHz, RC0/RC1 = 33 pF/33 pF, RC MODE)**



**FIGURE 14-9: MAXIMUM  $I_{PD}$  vs.  $V_{DD}$  BROWN-OUT DETECT ENABLED (85°C TO -40°C, RC MODE)**



**FIGURE 14-11: MAXIMUM  $I_{PD}$  vs. TIMER1 ENABLED (32 kHz, RC0/RC1 = 33 pF/33 pF, 85°C TO -40°C, RC MODE)**



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FIGURE 14-29: TYPICAL  $I_{DD}$  vs. FREQUENCY  
(HS MODE, 25°C)

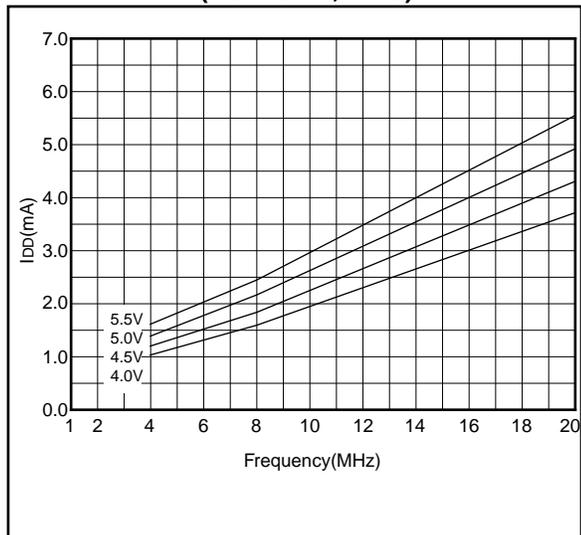
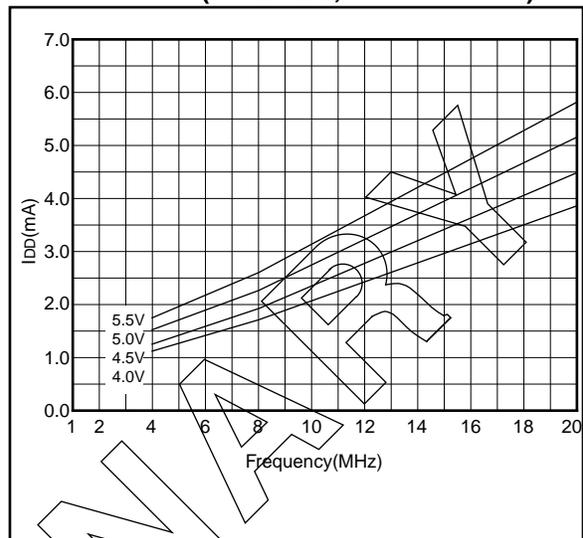


FIGURE 14-30: MAXIMUM  $I_{DD}$  vs.  
FREQUENCY  
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PRELIMINARY

# PIC16C71X

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NOTES:

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